nereby certify that this correspond is being deposited with the Conditional Service with sufficient postage as First Class Mail, in an envel addressed to: Commissioner for Patents Washington. DC 20231, of date shown below.

Dated: January 15, 2003 Signature

(Kimberly V. Perry)

JAN 3 0 2003

Docket No.: TESSERA 3.3-018 CONT CONT II CONT (PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Letters Patent of:

Khandros et al

Patent No.: 6,465,893

Issued: October 15, 2002

For: STACKED CHIP ASSEMBLY

Certificate of Correction Branch Commissioner for Patents Washington, DC 20231 Certificate

JAN 2 9 2003

of Correction

REQUEST FOR CERTIFICATE OF CORRECTION PURSUANT TO 37 CFR 1.323

Dear Sir:

Enclosed herewith is an original and one copy of a Certificate of Correction with respect to the above-identified U.S. Patent. You are hereby authorized to charge Deposit Account No. 12-1095 in the amount of \$100 to cover the required fee for filing a Certificate of Correction under § 1.323.

These errors were inadvertent, occurred in good faith and do not involve any changes which constitute new matter.

We look forward to early return of the copy of the Certificate of Correction duly certified.

By

Dated: January 15, 2003

Respectfully submitted,

Kimberly V. Perry

Registration No.: 43,612

LERNER, DAVID, LITTENBERG,

KRUMHOLZ & MENTLIK, LLP

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Westfield, New Jersey 07090

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Attorneys for Applicant

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UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO.

6,465,893 bl

DATED

October 15, 2002.

INVENTOR(S)

Igor Y. Khandros and Thomas H. DiStefano

It is certified that error appears in the above-identified patent and that said Letters

Patent is hereby corrected as shown below:

Cever page, (57), line 1, "chip assembly," should read --chip assembly--

Column 7, line 6, "overly" should read --overlie--

Column 11, line 45, "curved" should read --be curved--

Column 15, line 53, "method to according" should read --method according--

Column 15, line 56, "bonding 5 separately" should read --bonding separately--

Column 16, line 8, "encapsulant which may" should read --encapsulant may--

Column 18, line 3, "constitute a" should read --constitute an--

Column 26, line 20, "also band" should read -- also bend--

Column 30, line 60, "as a "I/O count" should read --as an "I/O count,"

Column 34, line 50, "contact" should read --contacts--

Column 35, line 54, "terminals disposed" should read --terminals are disposed--

Column 35, line 62, "claimed any" should read --claimed in any--

Column 36, line 65, "wherein central" should read --wherein a central--

Column 39, line 42, "contact" should read --contacts--

MAILING ADDRESS OF SENDER: Kimberly V. Perry Lerner, David, Littenberg, Krumholz & Mentlik, LLP 600 South Avenue West Westfield, New Jersey 07090

PATENT NO.: 6,465,893

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UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO.

6.465.893

DATED

October 15, 2002

INVENTOR(S)

Igor Y. Khandros and Thomas H. DiStefano

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MAILING ADDRESS OF SENDER: Kimberly V. Perry Lemer, David, Littenberg, Krumholz & Mentlik, LLP 600 South Avenue West Westfield, New Jersey 07090 PATENT NO.: 6,465,893

No. of additional copies:

UNITED STATES PATENT AND TRADEMARK OFFICE **CERTIFICATE OF CORRECTION**

PATENT NO.

: 6,465,893 B1

Page 1 of 2

DATED

: October 15, 2002

INVENTOR(S): Igor Y. Khandros and Thomas H. DiStefano

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Title page,

Item [57], ABSTRACT,

Line 1, "chip assembly," should read -- chip assembly --

Column 7,

Line 6, "overly" should read -- overlie --

Column 11,

Line 45, "curved" should read -- be curved --

Column 15,

Line 53, "method to according" should read -- method according --

Line 56, "bonding 5 separately" should read -- bonding separately --

Line 8, "encapsulant which may" should read -- encapsulant may --

Column 18,

Line 3, "constitute a" should read -- constitute an --

Column 26,

Line 20, "also band" should read -- also bend --

Column 30,

Line 60, "as a "I/O count" should read -- as an "I/O count --

Column 34,

Line 50, "contact" should read -- contacts --

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Column 35,

Line 62, "claimed any" should read -- claimed in any --

Column 36,

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UNITED STATES PATENT AND TRADEMARK OFFICE **CERTIFICATE OF CORRECTION**

PATENT NO.

: 6,465,893 B1

Page 2 of 2

DATED

: October 15, 2002

INVENTOR(S): Igor Y. Khandros and Thomas H. DiStefano

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 39,

Line 42, "contact" should read -- contacts --

Signed and Sealed this

Eleventh Day of March, 2003

JAMES E. ROGAN Director of the United States Patent and Trademark Office